06-04-1999



To the Honorable Commissioner of Patents and Trade

May 20, 1999

	101056171	Attorney Dkt 5649-726
Please record the attached original documents or copy thereof.		
Name of conveying party(ies):	2. Name and address of receiving par	ty(ies):
Ki-Won Lim Eui-Gyu Han Jeong-Un Choi	Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-City, Kyungki-do REPUBLIC OF KOREA	09/315695 09/315695 05/20/99
Additional name(s) of conveying party(ies) attached? Yes_X No		
3. Nature of conveyance:		
X Assignment Merger Security Agreement Change of Name Other		
Execution Date: May 6, 1999	Additional name(s) & address(es) attached?	Yes_X No
4. Application Serial NoPatent No.  If this document is being filed together with a new application is: May 6, 1999  Additional numbers attached?Yes _X_No  5. Name and address of party to whom correspondence concerning document should be mailed:  D. Scott Moore  Myers Bigel Sibley & Sajovec  P. O. Box 37428  Raleigh NC 27627	6. Total number of applications and p	\$40.0 <u>0</u>
DO NOT USE THIS SPACE		
9. Statement and signature  To the best of my knowledge and belief, the foregoing information of the original document.  D. Scott Moore, #42,011  Name of Person Signing  Total number of pages including cover sheet, attachments and documents.	<u>May 20, 1999</u> Date	copy is a true copy

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**PATENT** REEL: 009990 FRAME: 0817

## ASSIGNMENT

THIS ASSIGNMENT, made by us, **Ki-Won Lim**, citizen of the Republic of Korea, residing at 1020-33, Sandangl-dong, Donjak-ku, Seoul, Republic of Korea; **Eui-Gyu Han**, citizen of the Republic of Korea, residing at C-502, Dongnam Apt., 730-8, Mapyoung-dong, Yongin-shi, Kyunggi-do, Republic of Korea; and **Jeong-Un Choi**, citizen of the Republic of Korea, residing at 103-204, Cheoncheon Apt., Cheoncheon-dong, Jangan-ku, Suwon, Kyunggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in Integrated Circuit Devices Using Fuse Elements to Generate an Output Signal That is Independent of Cut Fuse Remnants for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. \_\_\_\_\_\_\_\_, filed \_\_\_\_\_\_\_) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-City, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

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PATENT REEL: 009990 FRAME: 0818 We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, we have hereunto set our hands and seals on this 6th day of May, 1999.

Ki-Won Lim
Ki-Won Lim
Eui-Gyu Ham
Eui-Gyu Han
Jeony- Un Chon Jeong-Un Choi

Witnes	sed by:
	Broker
Date:_	May 6,99
É	Bog. Bolu.
Date:_	1999.5.6.
	SennyHo lee
Date:	<b></b>

RECORDED: 05/20/1999